



## 40V N-Channel Trench Power MOSFET

### General Description

The SJH40ND110 uses advanced trench technology to provide excellent  $R_{DS(ON)}$ , low gate charge and operation with gate voltages as low as 4.5V. This device is suitable for use as a wide variety of applications.

### Features

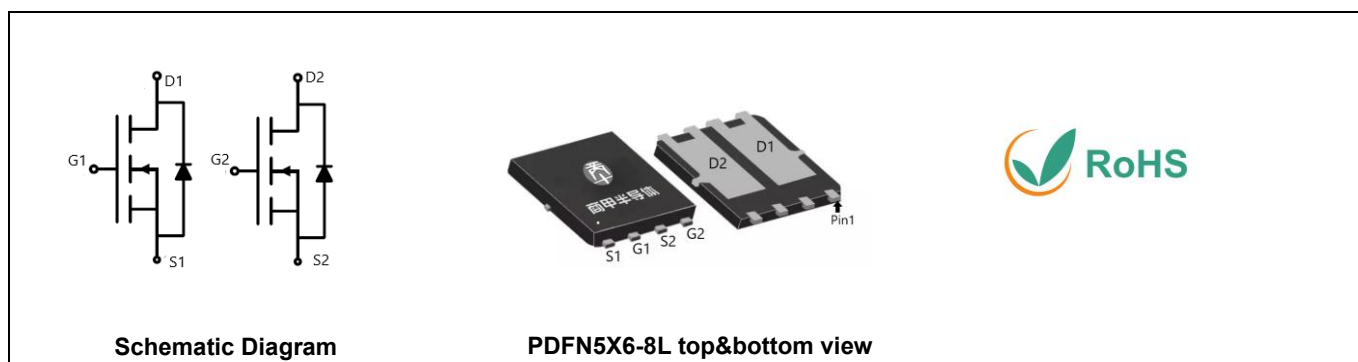
- Low Gate Charge
- 100% UIS Tested, 100% DVDS Tested
- High Power and current handling capability
- Lead free product is acquired

### Application

- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

### Key Performance Parameters

Parameter	Value	Unit
$V_{DS}$	40	V
$R_{DS(ON\_TYP)}$	14.1	m $\Omega$
$I_D$	27	A
$Q_G$	21	nC



### Package Marking and Ordering Information

Device/Ordering Code	Marking	Package	Packing	Reel Size	Tape width	Quantity
SJH40ND110	SJH40ND110	PDFN5X6	Tape	\	\	5000 Pcs

**Table 1. Absolute Maximum Ratings ( $T_C=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Limit	Unit
$V_{DS}$	Drain-Source Voltage ( $V_{GS}=0V$ )	40	V
$V_{GS}$	Gate-Source Voltage ( $V_{DS}=0V$ )	$\pm 20$	V
$I_D$	Drain Current-Continuous( $T_C=25^\circ\text{C}$ )	27	A
	Drain Current-Continuous( $T_C=100^\circ\text{C}$ )	17	A
$I_{DM}$ (pluse)	Drain Current-Continuous@ Current-Pulsed (Note 1)	108	A
$P_D$	Maximum Power Dissipation( $T_C=25^\circ\text{C}$ )	22	W
	Maximum Power Dissipation( $T_C=100^\circ\text{C}$ )	8.7	W
$E_{AS}$	Avalanche energy (Note 2)	56	mJ
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	-55 To 150	$^\circ\text{C}$

**Table 2. Thermal Characteristic**

Symbol	Parameter	Typ	Max	Unit
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case		5.76	$^\circ\text{C}/\text{W}$



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**Table 3. Electrical Characteristics ( $T_J=25^\circ\text{C}$  unless otherwise noted)**

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>On/Off States</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\mu A$	40			V
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=40V, V_{GS}=0V, T_J=25^\circ\text{C}$			1	$\mu A$
		$V_{DS}=40V, V_{GS}=0V, T_J=125^\circ\text{C}$			100	$\mu A$
$I_{GSS}$	Gate-Body Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0V$			$\pm 100$	nA
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_D=250\mu A$	1		2.5	V
$g_{FS}$	Forward Transconductance	$V_{DS}=5V, I_D=15A$		26		S
$R_{DS(on)}$	Drain-Source On-State Resistance	$V_{GS}=10V, I_D=15A, T_J=25^\circ\text{C}$		14.1	17.6	m $\Omega$
		$V_{GS}=4.5V, I_D=10A, T_J=25^\circ\text{C}$		17.1	22.7	m $\Omega$
<b>Dynamic Characteristics</b>						
$C_{iss}$	Input Capacitance	$V_{DS}=20V, V_{GS}=0V, f=1.0\text{MHz}$		978		pF
$C_{oss}$	Output Capacitance			83		pF
$C_{rss}$	Reverse Transfer Capacitance			73		pF
$R_g$	Gate resistance	$V_{GS}=0V, V_{DS}=0V, f=1.0\text{MHz}$		2.2		$\Omega$
<b>Switching Parameters</b>						
$t_{d(on)}$	Turn-on Delay Time	$V_{GS}=10V, V_{DS}=20V, R_L=1.3\Omega, R_{GEN}=6\Omega$		15		nS
$t_r$	Turn-on Rise Time			22		nS
$t_{d(off)}$	Turn-Off Delay Time			35		nS
$t_f$	Turn-Off Fall Time			24		nS
$Q_g$	Total Gate Charge	$V_{GS}=10V, V_{DS}=20V, I_D=15A$		21		nC
$Q_{gs}$	Gate-Source Charge			3.5		nC
$Q_{gd}$	Gate-Drain Charge			5		nC
<b>Source-Drain Diode Characteristics</b>						
$I_{SD}$	Source-Drain Current (Body Diode)				27	A
$V_{SD}$	Forward on Voltage (Note 3)	$V_{GS}=0V, I_S=15A$			1.2	V
$t_{rr}$	Reverse Recovery Time	$I_F=15A, dI/dt=100A/\mu s$		19.5		ns
$Q_{rr}$	Reverse Recovery Charge	$I_F=15A, dI/dt=100A/\mu s$		17		nC

Notes 1.Repetitive Rating: Pulse width limited by maximum junction temperature.

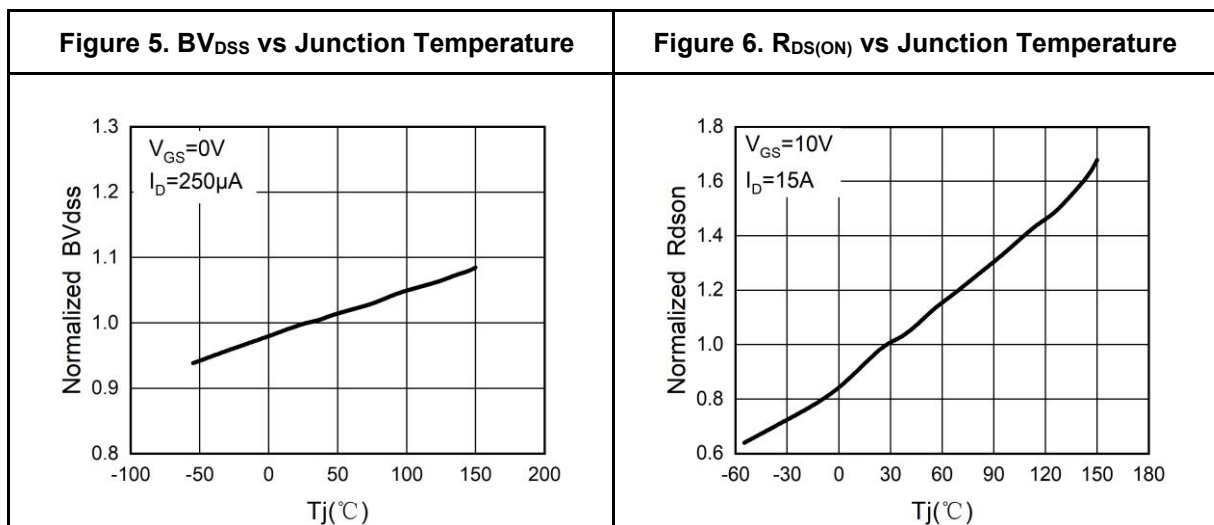
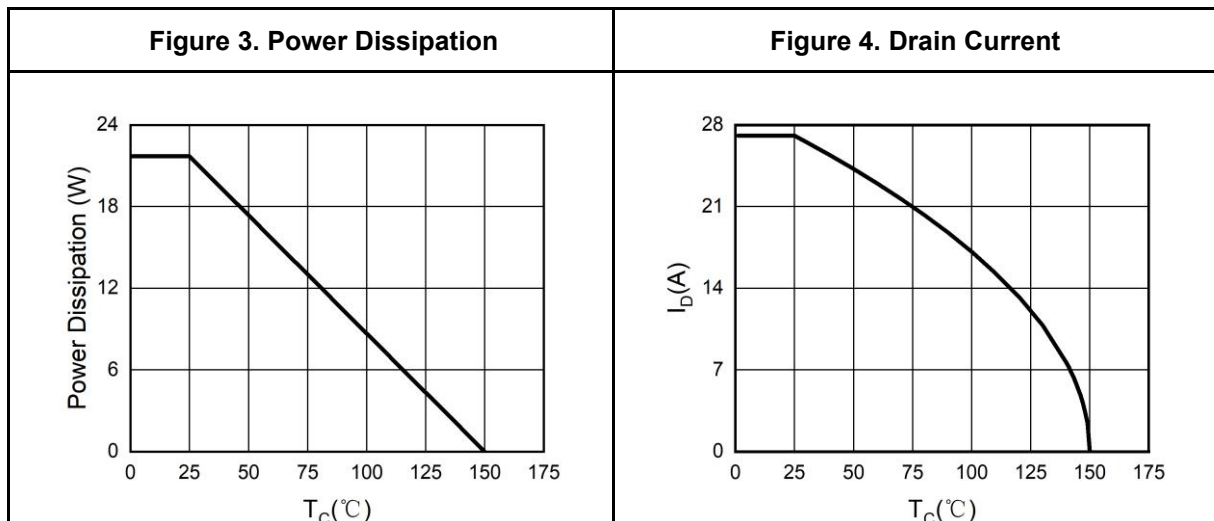
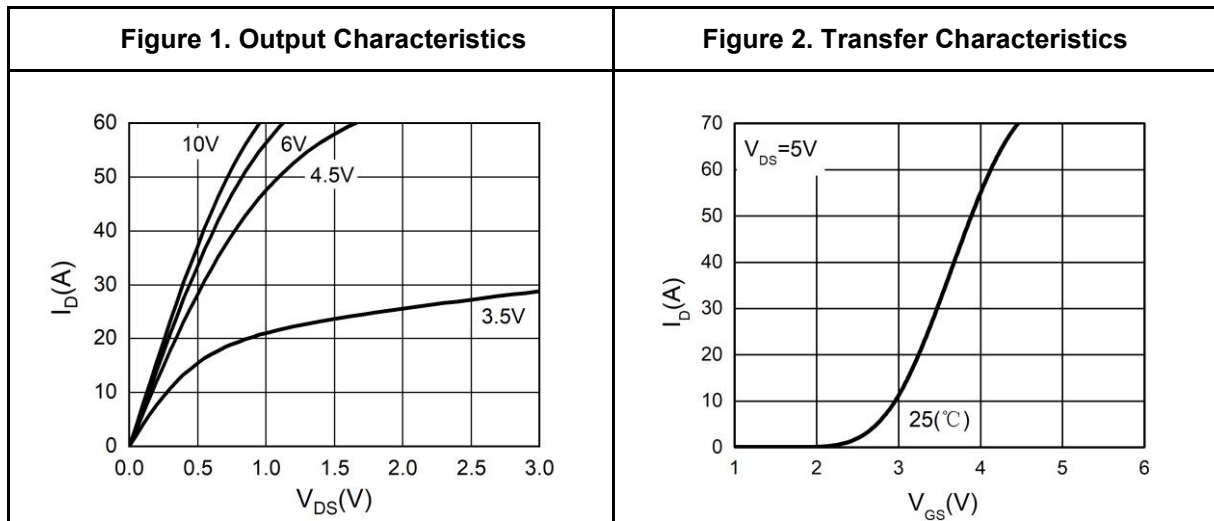
Notes 2.EAS condition:  $T_J=25^\circ\text{C}, V_{DD}=40V, V_G=10V, R_g=25\Omega, L=0.5\text{mH}$ .

Notes 3.Repetitive Rating: Pulse width limited by maximum junction temperature.



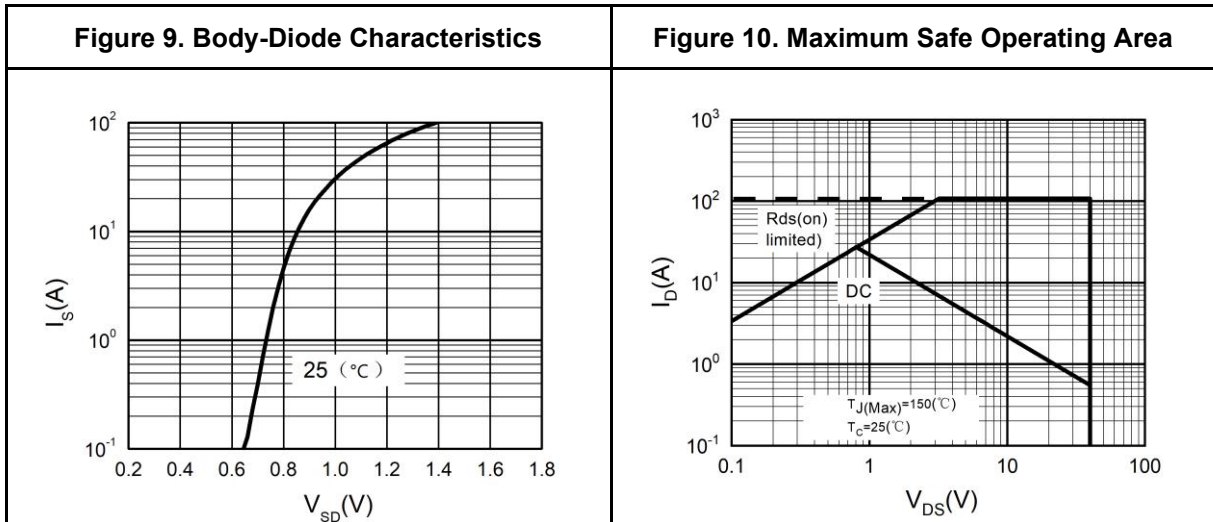
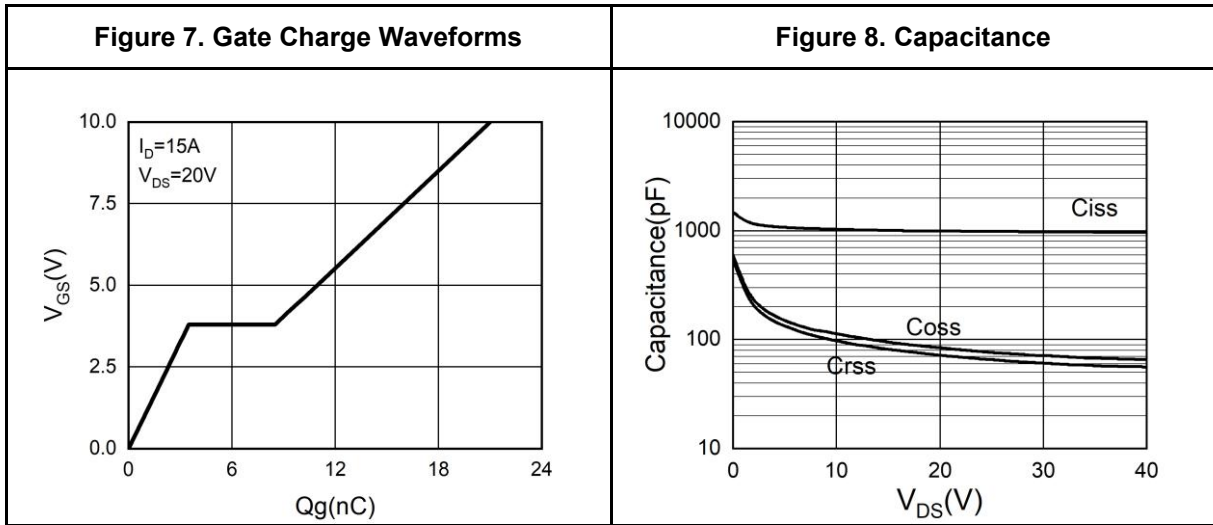
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## Typical Electrical And Thermal Characteristics (Curves)



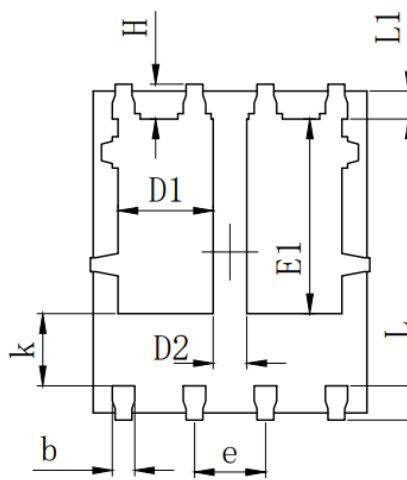
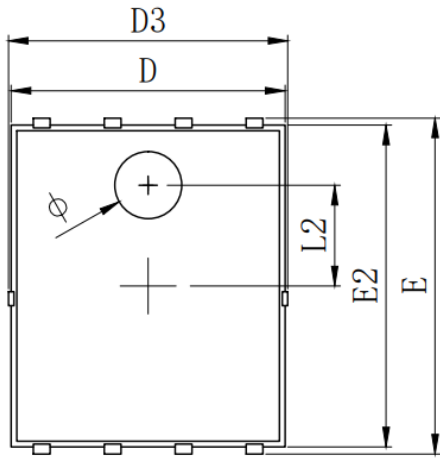


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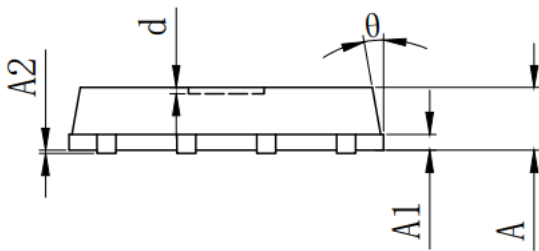




PDFN5X6-8L Package Information



SYMBOL	MILLIMETER		
	MIN	Typ.	MAX
A	0.900	1.000	1.100
A1	0.254 REF.		
A2	0 <sup>~</sup> 0.05		
D	4.824	4.900	4.976
D1	1.605	1.705	1.805
D2	0.500	0.600	0.700
D3	4.924	5.000	5.076
E	5.924	6.000	6.076
E1	3.375	3.475	3.575
E2	5.674	5.750	5.826
b	0.350	0.400	0.450
e	1.270 TYP.		
L	0.534	0.610	0.686
L1	0.424	0.500	0.576
L2	1.800 REF.		
k	1.190	1.290	1.390
H	0.549	0.625	0.701
$\theta$	8°	10°	12°
$\phi$	1.100	1.200	1.300
d			0.100





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### Attention

This product described in this document can not be used in life support devices or systems, aircraft's control systems, and other applications whose failure can be reasonably expected to result in serious physical and/or material damage, apart from that when an application agreement is signed between customer and Wuxi Shangjia Semiconductor.

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